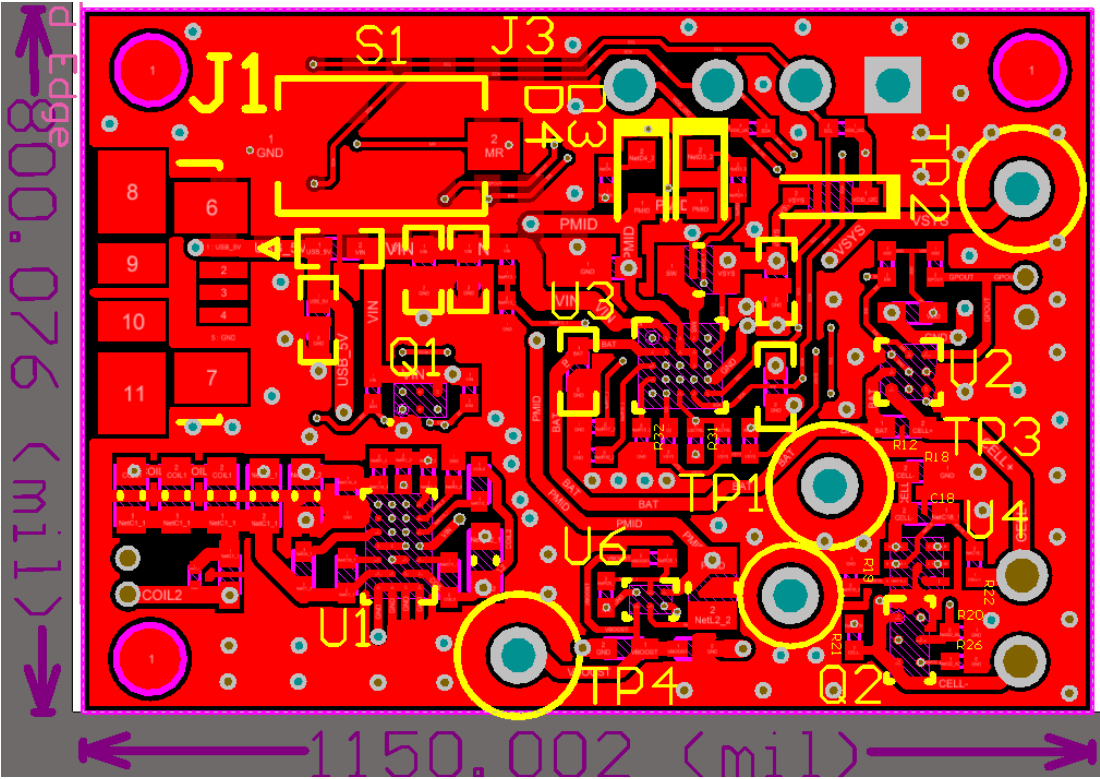
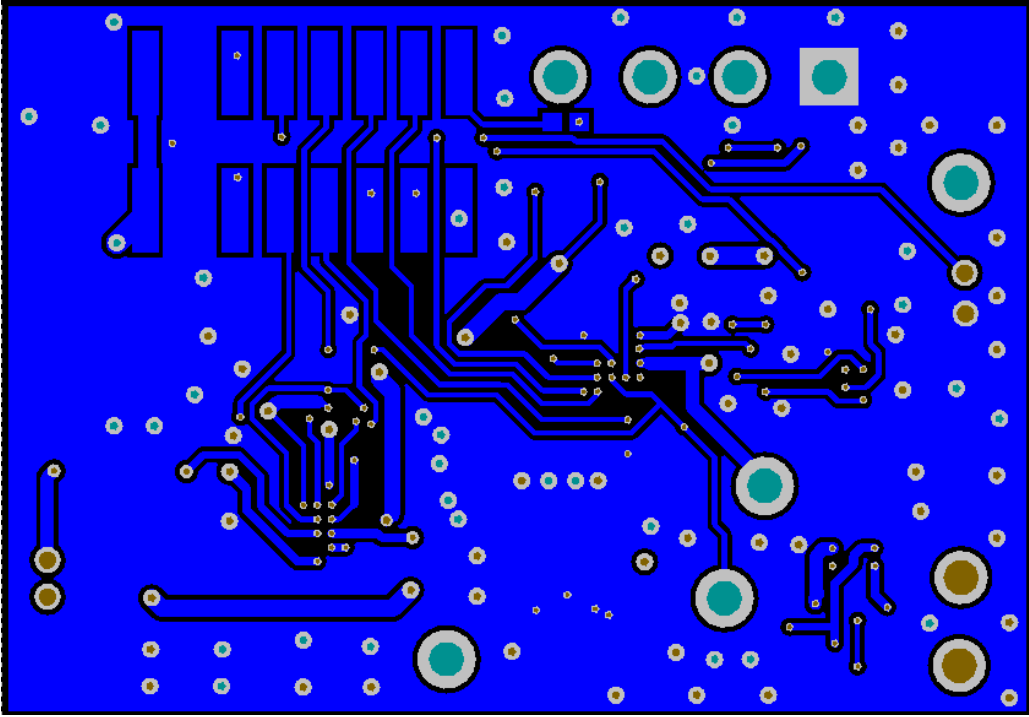


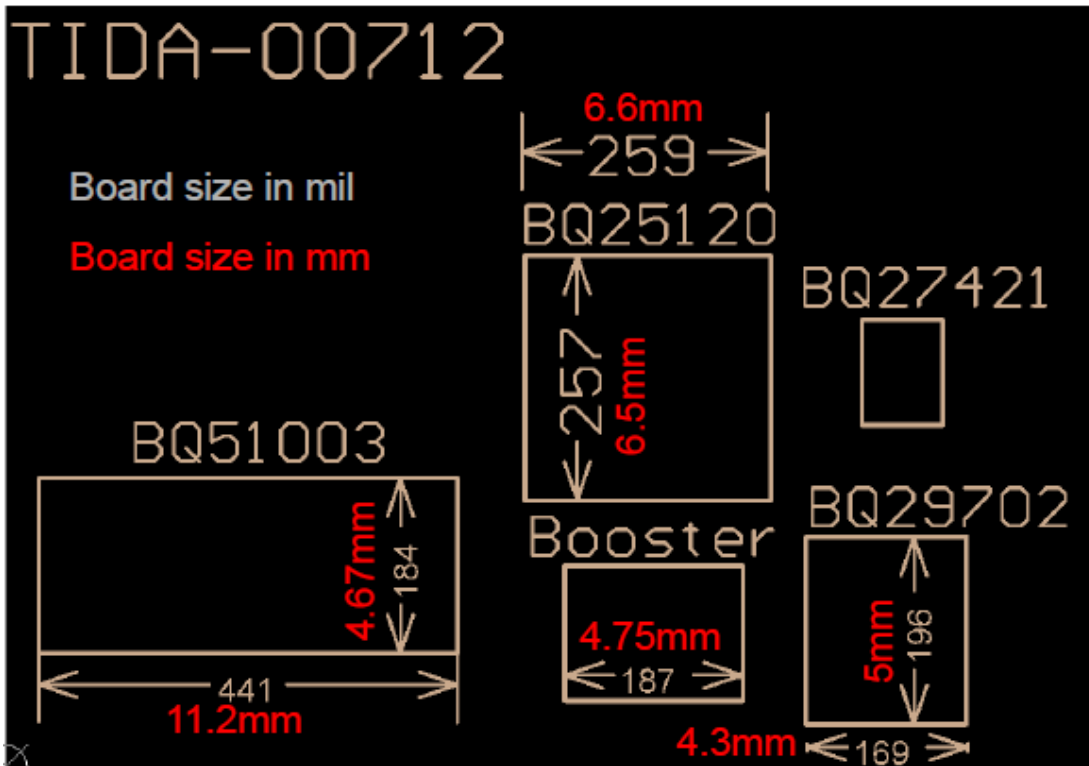
PCB top layer printout:



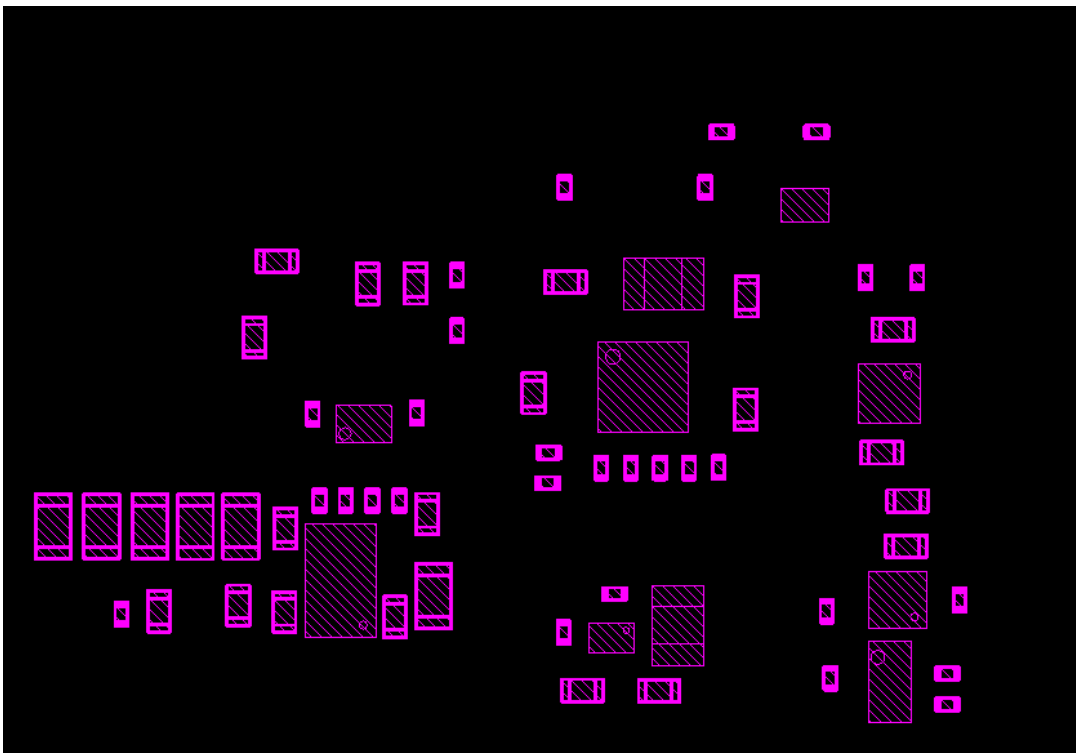
PCB bottom layer printout:



PCB bottom over layer printout shows each circuit size below:



PCB components body printout shows below:



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